

恒拓电子  
HENG TUO ELECTRONICS



# *HT series*

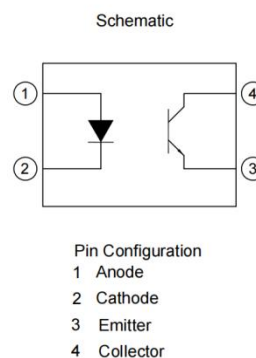
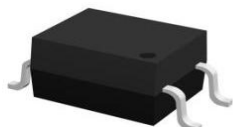
## Photocoupler Product Data Sheet

# HT-357X

Spec No:HT-PC-357X-P-009-A1  
Effective Date:07/03/2024

Zhejiang Hengtuo Electronic technology Co.,Ltd  
298 Yongqing Road,Nanhu District,jiaying City,Zhengjiang Province  
Tel:0573-82819382  
<https://hengtuo-elec.com>

## ■ Package



## ■ Description

The HT-357X is a photoelectric coupler composed of light-emitting diode and phototransistor. It is packaged in a 4-pin package .

## ■ Features

- Current transfer ratio(CTR : MIN. 50% at  $I_F = 5\text{mA}$ ,  $V_{CE} = 5\text{V}$ )
- High input-output isolation voltage( $V_{iso} = 3,750\text{V}_{rms}$ )
- Operating Temperature:  $-55^{\circ}\text{C} \sim 110^{\circ}\text{C}$
- Safety approval  
(UL 1577, VDE DIN EN60747-5-5 (VDE 0884-5) , CQC11-471543-2022)
- RoHS
- MSL1

## ■ Applications

- Programmable controllers
- Switching power supply, intelligent meter
- Home appliances: such as air conditioners, fans, water heaters, etc



## ■ Product Nomenclature

The product name is designated as below:

HT -357 X -X X- X X X- XX

① ② ③ ④ ⑤ ⑥ ⑦

Designation:

HT =Hengtuo Technology Co.,LTD.

357= Product Series

① = Lead form option(NONE)<sub>(1)</sub>

② = CTR Rank(A,B,C,D,E)<sub>(2)</sub>

③ = Tape and Reel option(TP,TP1)<sub>(3)</sub>

④ = Lead frame Material(F,NONE)<sub>(4)</sub>

⑤ = VDE order option(fixed code "V")

⑥ = Halogen free option(fixed code"G")

⑦ = Customer code

### Notes

#### 1. Lead form option:

Symbol	Description
NONE	SOP4

#### 2. CTR Rank:

Symbol	Description
A,B,C,D,E...	CTR Rank
NONE	No Rank

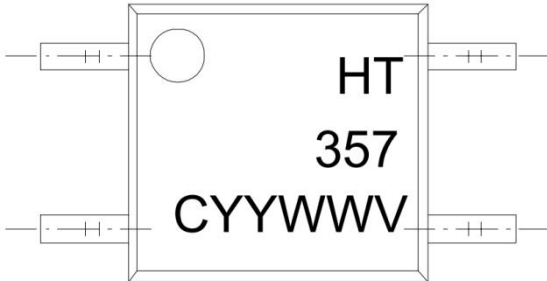
#### 3. Tape and Reel option:

Symbol	Description
TP&TP1	Tape and Reel Type

#### 4. Lead frame Material

Symbol	Description
NONE	Copper

## ■ Marking Information



### Designation:

HT	denotes Hengtuo
357	denotes Device
C	denotes CTR Rank
YY	denotes year code
WW	denotes week code
V	denotes VDE

## ■ Maximum Ratings

	Parameter	Symbol	Values	Unit
Input	Forward Current	$I_F$	50	mA
	Reverse Voltage	$V_R$	6	V
	Power Dissipation		70	mW
	Derating factor (above $T_a = 90^\circ\text{C}$ )	$P_D$	2.9	mW/ $^\circ\text{C}$
Output	Collector - Emitter Voltage	$V_{CEO}$	80	V
	Emitter - Collector Voltage	$V_{ECO}$	7	V
	Collector Current	$I_C$	50	mA
	Collector Power Dissipation		150	mW
	Derating factor (above $T_a = 70^\circ\text{C}$ )	$P_C$	3.7	mW/ $^\circ\text{C}$
Operating temperature range		$T_{op}$	-55 ~ 110	$^\circ\text{C}$
Storage temperature range		$T_{stg}$	-55 ~ 125	$^\circ\text{C}$
Total Power consumption		$P(W)$	200	mW
Isolation Voltage <sup>(1)</sup>		$V_{ISO}$	3750	$V_{rms}$
Soldering Temperature <sup>(2)</sup>		$T_{SOL}$	260	$^\circ\text{C}$

### Notes:

(1). AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

(2).For 10 seconds

## ■ Electronic Optical Characteristics (TA = 25°C)

	Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditon
Input	Forward Voltage	$V_F$	-	1.2	1.4	V	$I_F=20\text{mA}$
	Reverse Current	$I_R$	-	-	10	$\mu\text{A}$	$V_R=4\text{V}$
	Terminal Capacitance	$C_t$	-	30	250	$\text{pF}$	$V=0, f=1\text{KHz}$
Output	Collector Dark Current	$I_{CEO}$	-	-	100	nA	$V_{CE}=20\text{V}, I_F=0$
	Collector-Emitter Breakdown Voltage	$BV_{CEO}$	80			V	$I_C=0.1\text{mA}, I_F=0$
	Emitter-Collector Breakdown Voltage	$BV_{ECO}$	7			V	$I_E=10\mu\text{A}, I_F=0$
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$		0.1	0.2	V	$I_F=20\text{mA}, I_C=1\text{mA}$
	Isolation Resistance	$R_{iso}$	$5 \times 10^{10}$	$1 \times 10^{11}$	-	$\Omega$	DC500V, 40 ~ 60% R.H.
	Floating Capacitance	$C_f$		0.6	1	$\text{pF}$	$V=0, f=1\text{MHz}$
	Cut-off Frequency	$f_c$		80		$\text{kHz}$	$V_{CE}=5\text{V}, I_C=2\text{mA}, R_L=100\Omega, -3\text{dB}$
	Response Time (Rise)	$t_r$		4	18	$\mu\text{s}$	$V_{CE}=2\text{V}, I_C=2\text{mA}$
	Response Time (Fall)	$t_f$		3	18	$\mu\text{s}$	$R_L=100\Omega,$

## ■ Rank Table Of Current Transfer Ratio (CTR= $I_C/I_F \times 100\%$ )

Rank Code	Symbol	Min	Max	Conditon
NONE	CTR	50	600	$I_F=5\text{mA}, V_{CE}=5\text{V}, T_a=25^\circ\text{C}$
A		80	160	
B		130	260	
C		200	400	
D		300	600	

## ■ Characteristics Curves

Fig.1 Relative Current Transfer Ratio vs. Forward Current

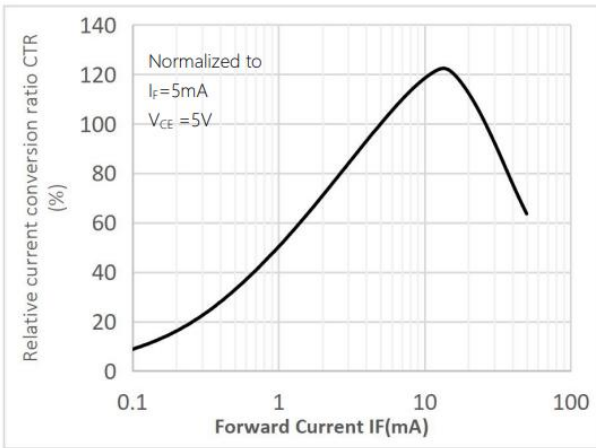


Fig.2 Forward Current vs. Forward Voltage

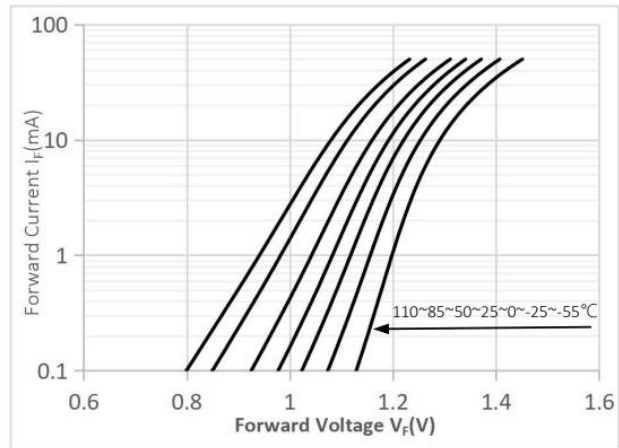


Fig.3 Collector Current vs. Collector-emitter Voltage

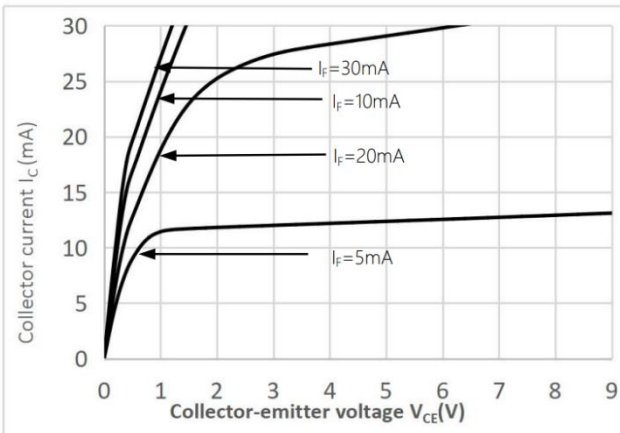


Fig.4 Relative Current Transfer Ratio vs. Ambient Temperature

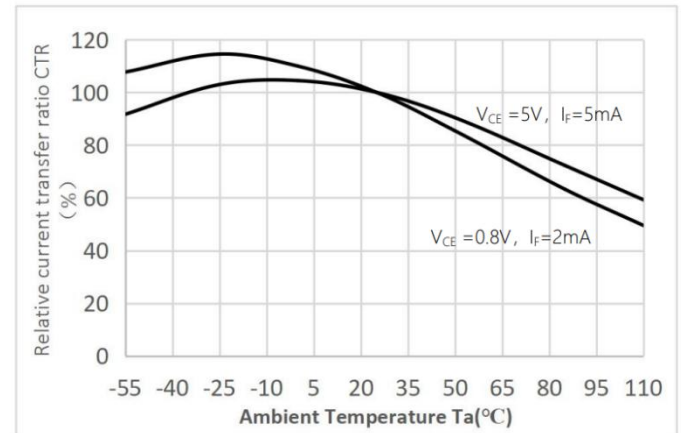


Fig.5 Collector-emitter Saturation Voltage vs. Ambient Temperature

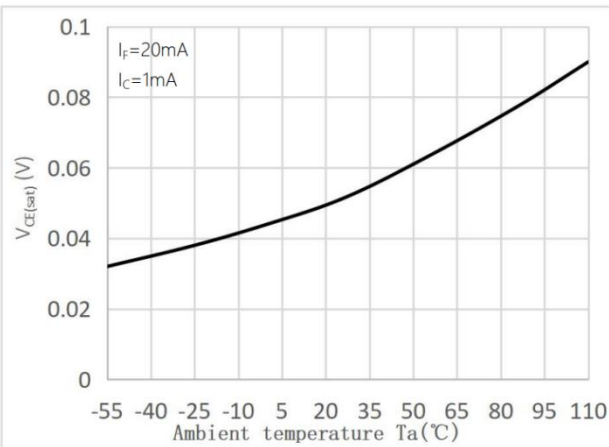


Fig.6 Collector Dark Current vs Ambient Temperature

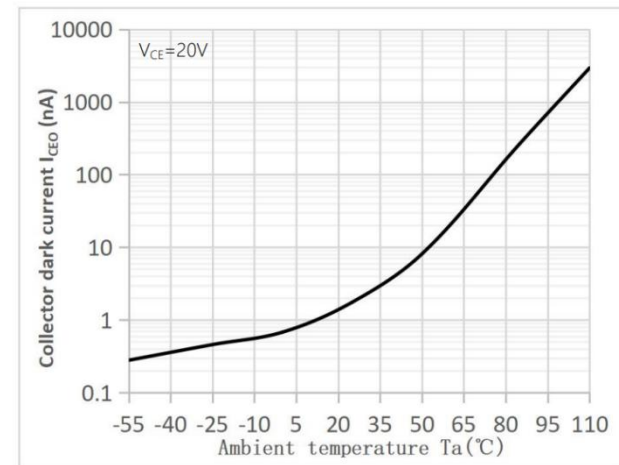


Fig.7 Response Time vs. Load Resistance

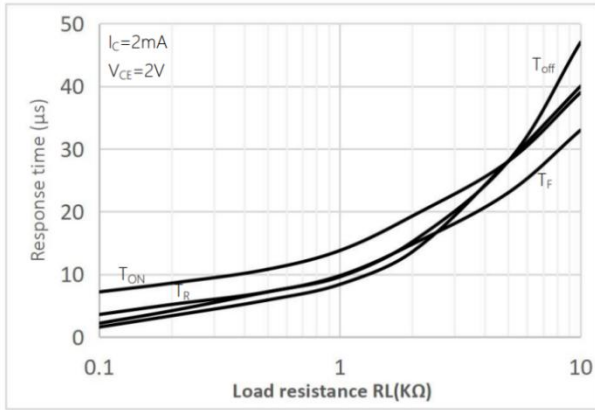


Fig.8 Frequency Response

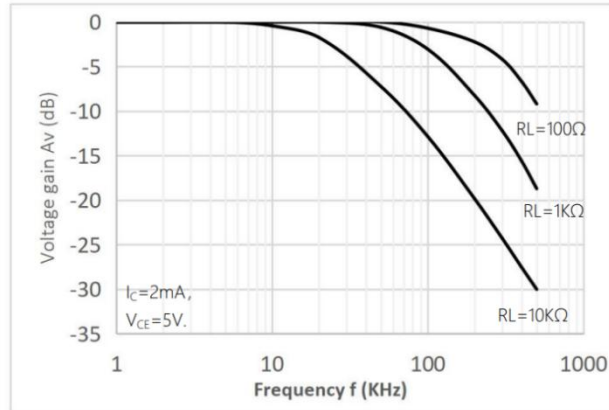


Fig.9 Collector-emitter Saturation Voltage vs Forward Current

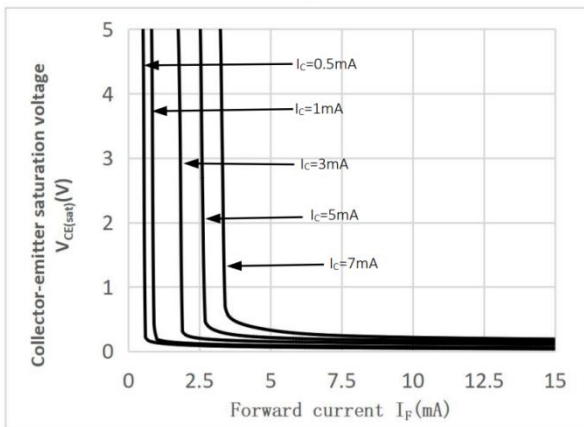
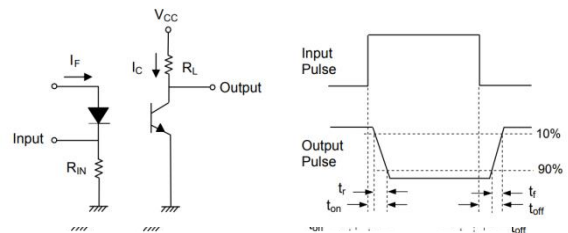
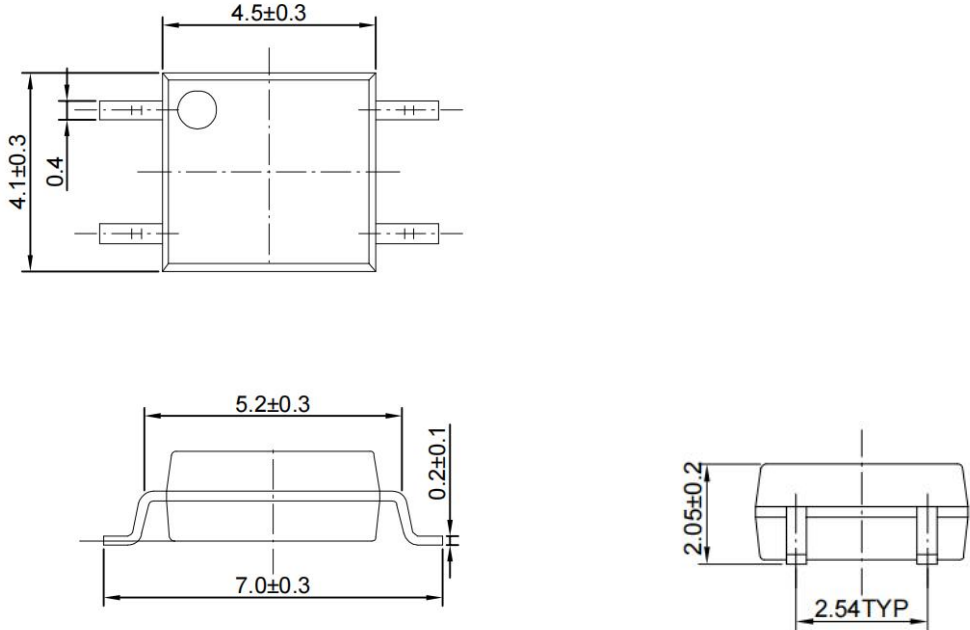


Fig.10 Switching Time Test Circuit & Waveforms

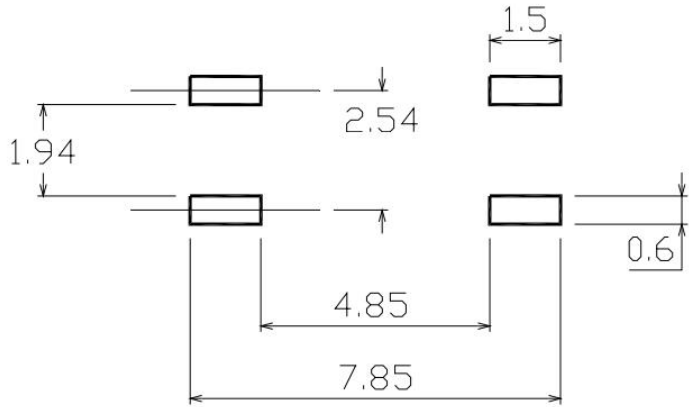


### ■ Outline Dimension



Unit: mm  
Tolerance:  $\pm 0.1$  mm

### ■ Recommended solder pad Design



Unit: mm  
Tolerance:  $\pm 0.1$  mm

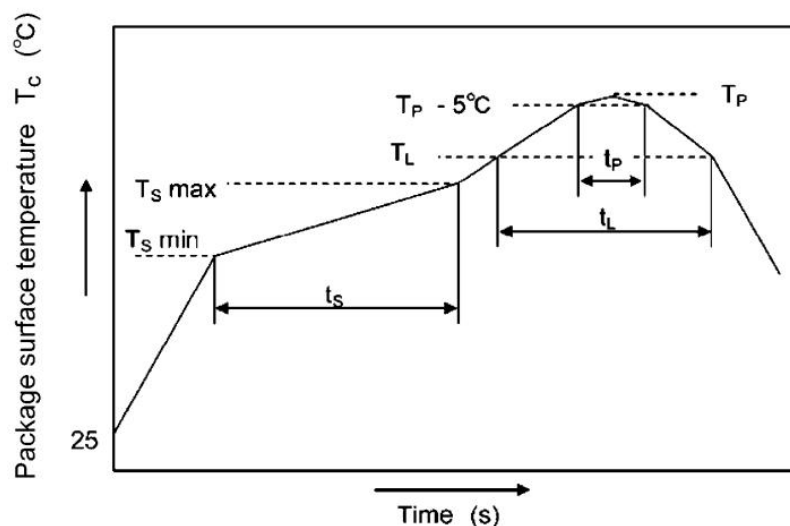


## ■ Temperature Profile Of Soldering

### 1. IR Reflow soldering

**(JEDEC-STD-020D compliant)**

Profile item	Condition
Preheat	
-Temperature Min (TSmin)	150°C
-Temperature Max (TSmax)	200°C
-Time (min to max) (ts)	90 ± 30 sec
Soldering zone	
-Temperature (TL)	217°C
-Time (tL)	60-150 sec
Peak Temperature (TP)	260°C
-Time (TP-5°C to TP) (ts)	30 sec
Ramp-up rate	3°C / sec max
Ramp-down rate	3~6°C/ sec



#### Notes:

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

## 2. Wave soldering (JEDEC22A111 compliant)

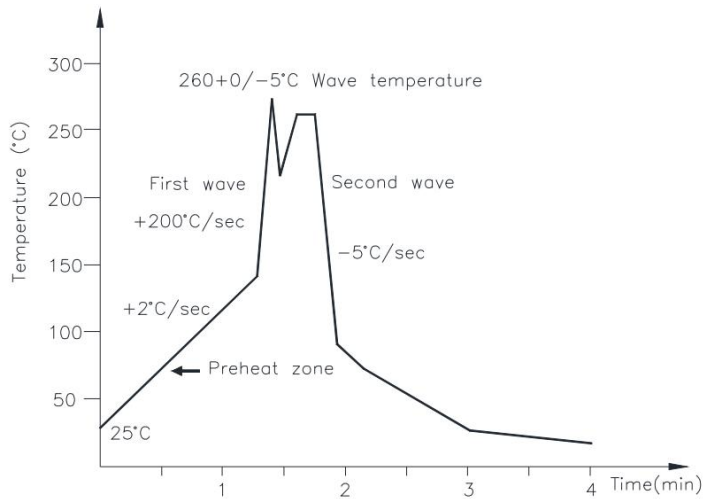
One time soldering is recommended within the condition.

Temperature:  $260 \pm 0 / -5^{\circ}\text{C}$ .

Time: 10 sec.

Preheat temperature: 25 to  $140^{\circ}\text{C}$ .

Preheat time: 30 to 80 sec.



## 3. Hand soldering by soldering iron

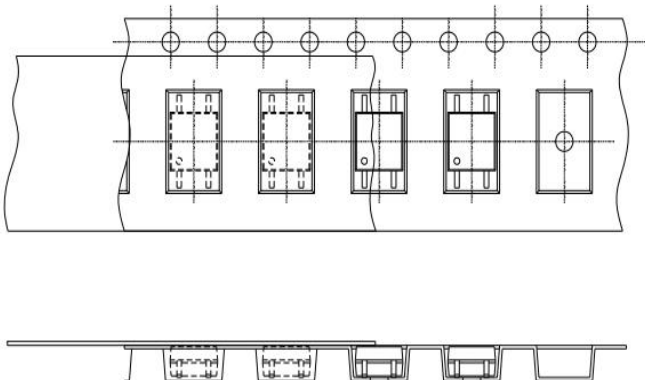
Allow single lead soldering in every single process. One time soldering is recommended.

Temperature:  $380 \pm 0 / -5^{\circ}\text{C}$

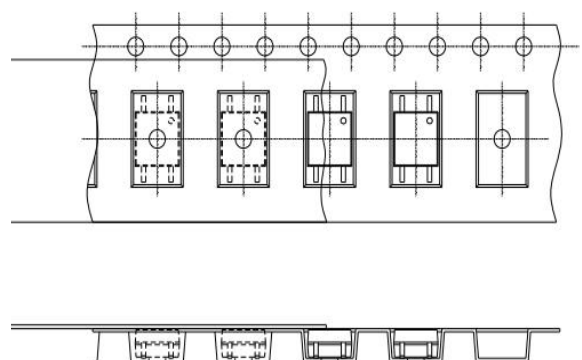
Time: 3 sec max.

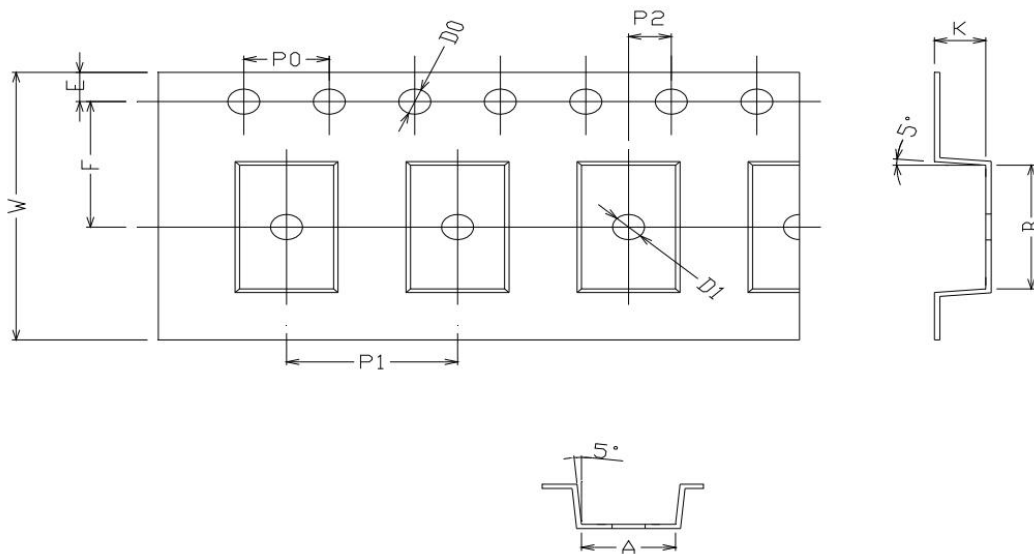
## ■ Packing Tape and Reel

Option TP:



Option TP1:





Deminsion/mm	W	E	F	P0	P1	P2
Packagetype:S	$16 \pm 0.2$	$1.75 \pm 0.1$	$7.5 \pm 0.1$	$4 \pm 0.1$	$8 \pm 0.1$	$2 \pm 0.1$

Deminsion/mm	A	B	D0	D1	K
Packagetype:S	$4.4 \pm 0.1$	$7.5 \pm 0.1$	$1.5 \pm 0.1$	$1.5 \pm 0.1$	$2.4 \pm 0.1$

Packagetype:S	Reel	Inner carton	Outer carton
QTY/PCS	3K/reel	6K(2 reels)	60K

## ■ Attention:

- Hengtuo is continually improving the quality, reliability, function or design and Hengtuo reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.